505683909 09/20/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5730719

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KENNETH MARION CUREWITZ	09/09/2019
SEAN S. EILERT	09/09/2019
HONGYU WANG	09/09/2019
SAMUEL E. BRADSHAW	09/18/2019
SHIVASANKAR GUNASEKARAN	09/09/2019
JUSTIN M. ENO	09/09/2019
SHIVAM SWAMI	09/09/2019

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.	
Street Address:	8000 SOUTH FEDERAL WAY	
City:	BOISE	
State/Country:	IDAHO	
Postal Code: 83707		

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16573541	

CORRESPONDENCE DATA

Fax Number:(415)707-2010Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

16503288500
Wardadm@gtlaw.com
EMA MAJIC
GREENBERG TRAURIG, LLP
77 WEST WACKER DRIVE, SUITE 3100
CHICAGO, ILLINOIS 60601

	-
ATTORNEY DOCKET NUMBER: 120426-324600/US	
NAME OF SUBMITTER:	EMA MAJIC
SIGNATURE:	/Ema Majic/
DATE SIGNED:	09/20/2019

505683909

PATENT REEL: 050449 FRAME: 0001

Total Attachments: 7	
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source=120426-324600_Assignment_Patent_Serial_No_16573541#page7.tif	

TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, as the below named inventor of an invention entitled:

MAPPING NON-TYPED MEMORY ACCESS TO TYPED MEMORY ACCESS

which is described in:

- I the attached application, or
- United States Patent Application Serial Number _ filed on _,

THE UNDERSIGNED does hereby:

SELL, ASSIGN AND TRANSFER to Micron Technology. Inc., a corporation organized and existing under the laws of the State of Delaware, and having a place of business at 8000 South Federal Way. Boise, ID 83707, US (hereinafter referred to as ASSIGNEE), which is desirous of acquiring the entire interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefore in the United States and in any and all foreign countries, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the ASSIGNEE;

WARRANT AND COVENANT that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the ASSIGNEE all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the ASSIGNEE shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the ASSIGNEE;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the ASSIGNEE.

Legal Name	Last Name	First Name	Middle Name
of Inventor	Curewítz	Kenneth	Marion
Residence	City	State & Country	Country of Citizenship
& Citizenship	Cameron Park	CA, US	US
Mailing	Street	City	State & Zip Code
Address	408 Ashland Court	Cameron Park	CA 95682, US
Signature of Inv	entor: The Maron Cureutz	Da	se: 9/9//9
s <u>k.</u> fittakatutut	<u> </u>		

PATENT REEL: 050449 FRAME: 0003

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Legal Name	Last Name	First Name	Middle Name
of Inventor	Eilert	Sean	S.
Residence	City	State & Country	Country of Citizenship
& Citizenship	Penryn	CA, US	US
Mailing	Street	City	State & Zip Code
Address //	1721 English Colony Way	Penryn	CA 95663, US
Signature of Invo		Da	10: 9/9/19

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Legal Name	Last Name	First Name	Middle Name
of Inventor	Wang	Hongyu	
Residence	City	State & Country	Country of Citizenship
& Citizenship	Folsom	CA, US	CN
Mailing	Street	City	State & Zip Code
Address	1225 Meredith Way	Folsom	CA 95630, US
Signature of Inventor		Dai	te: 919 (2019

PATENT REEL: 050449 FRAME: 0005

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- ☑ United States Patent Application Serial Number 16/573,541 filed on 09-17-2019,

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Legal Name	Last Name	First Name	Middle Name
of Inventor	Bradshaw	Samuel	E.
Residence	City	State & Country	Country of Citizenship
& Citizenship	Sacramento	CA, US	US
Mailing	Street	City	State & Zip Code
Address	6319 Surfside Way	Sacramento	CA 95831, US
Signature of Inv	entor:	D:	ste:

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Legal Name	Last Name	First Name	Middle Name
of Inventor	Gunasekaran	Shivasankar	
Residence	City	State & Country	Country of Citizenship
& Citizenship	Folsom	CA, US	IN
Mailing	Street	City	State & Zip Code
Address	200 S Lexington Dr, Apt 935	Folsom	CA 95630, US
Signature of Inx	eștor:		Date: 09/09/2019

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Legal Name	Last Name	First Name	Middle Name
of Inventor	Eno	Justin	M.
Residence	City	State & Country	Country of Citizenship
& Citizenship	El Dorado Hills	CA, US	US
Mailing	Street	City	State & Zip Code
Address	3844 Yellowstone Lane	El Dorado Hills	CA 95762, US
Signature of Inventor:		Da	*** 9/9/2019

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Legal Name	Last Name	First Name	Middle Name
of Inventor	Swami	Shivani	
Residence	City	State & Country	Country of Citizenship
& Citizenship	Foisom	CA, US	IN
Mailing Address	Street 200 South Lexington Drive, Apt 816	City Folsom	State & Zip Code CA 95630, US
Signature of Inventor:			ne: Sept 9,2019